Doket	No:		
1201001	1 10	 	

patent issued thereon.



DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

222011000111	NESCENCE DEVICE		RIVING CIRCUIT	OR ORGANIC
the specification of parts	<i>y</i>			
[X] is attached hereto		as Application Seria		_and was
SEP 1 2 2001	amended or		pplicable)	ns, as amended by any amendment
referred to about ADEMAN	exiewed and understand the con	tents of the above identified speci	incation, including the claim	is, as amended by any amendment
1 acknowledge the duty to a Section 1.56(a).	tisclose information which is kno	wn to me to be material to patenta	bility in accordance with Tit	le 37, Code of Federal Regulations,
inventor's certificate, or pro	ovisional application(s) listed be		w any foreign application for	foreign application(s) for patent or or patent or inventor's certificate, or
Prior Foreign Application(s)	or U.S. Provisional Application(s)) :	Priority Claimed	
Number	Country	Day/Month/Year	Yes	<u>No</u>
2000-43711	Korea	28/July/2000	X	
			s application(s) listed below	and, insofar as the subject matter of
each of the claims of this a States Code, Section 112, 1	application is not disclosed in the acknowledge the duty to disclos	prior United States application in the material information as defined	the manner provided by the in Title 37, Code of Federal	first paragraph of Title 35, United Regulations, Section 1.56(a) which
each of the claims of this a States Code, Section 112, I occurred between the filing	application is not disclosed in the acknowledge the duty to disclos	prior United States application in	the manner provided by the in Title 37, Code of Federal	first paragraph of Title 35, United
each of the claims of this a States Code, Section 112, I occurred between the filing Prior U. S. Application(s):	application is not disclosed in the acknowledge the duty to disclos date of the prior application and the	prior United States application in the material information as defined	the manner provided by the in Title 37, Code of Federal ag date of this application:	first paragraph of Title 35, United Regulations, Section 1.56(a) which
each of the claims of this a States Code, Section 112, I occurred between the filing	application is not disclosed in the acknowledge the duty to disclos	prior United States application in the material information as defined	the manner provided by the in Title 37, Code of Federal	first paragraph of Title 35, United Regulations, Section 1.56(a) which

both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any





I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vasquez, Registration No. 36,647, all of

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With full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

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